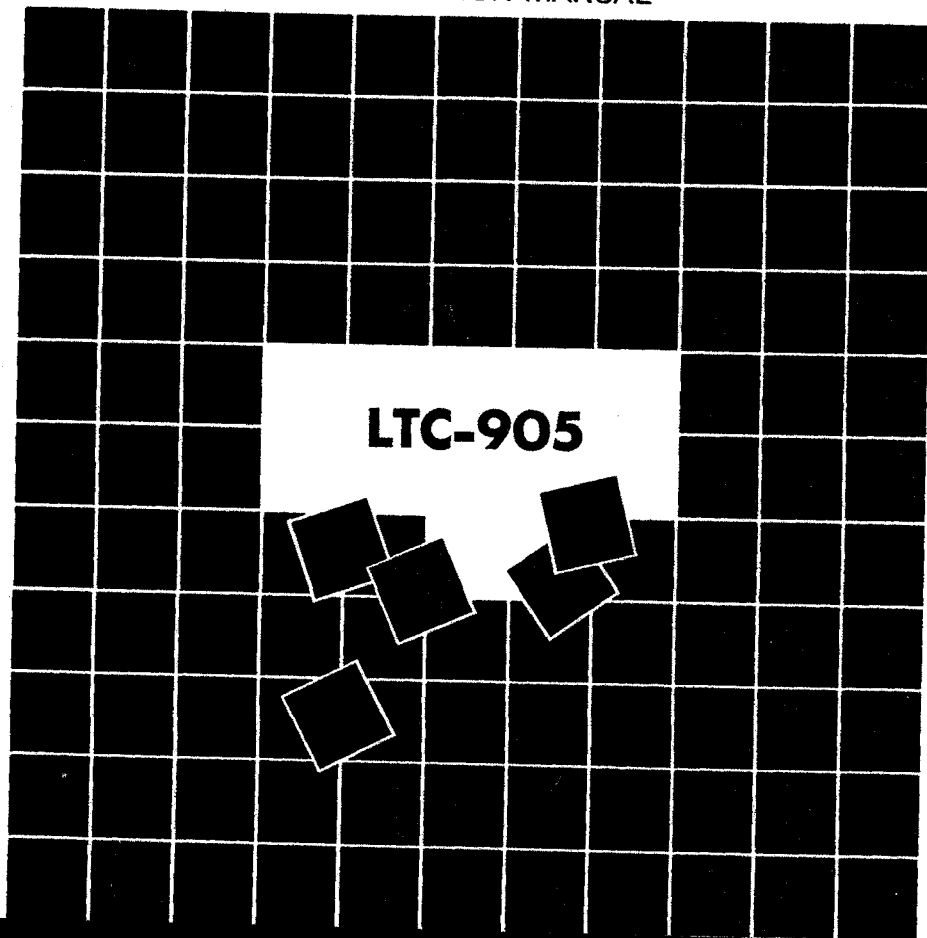


LEADER

CURVE TRACER

INSTRUCTION MANUAL



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1. DESCRIPTION

Curve tracing on a scope is made easy with the LTC-905. Characteristic curves of all types of semiconductors can be accurately displayed. This is far superior to the conventional ohmmeter checks for quality. In-circuit testing is possible for quick checks.

Two inputs are provided which enable comparison of two similar units.

LTC-905 is designed to test the following:

1. Transistors - NPN, PNP, FET and MOS FET.
2. SCR's (Thyristors) and Triacs.
3. Diodes - rectifier, detector, zener and tunnel.

2. SPECIFICATIONS

Collector/Drain Sweep	
Frequency	120Hz, or 100Hz (2 x line frequency).
Voltage	8 steps: 10, 20, 30, 40, 50, 60, 80 and 100V; accuracy, $\pm 10\%$. (Rated voltage)
Sweep Waveform	Fullwave rectified.
Current	100mA, maximum.
Current Limiter	1000 Ω for low level transistors; 100 Ω for power transistors.
Step Generator	
No. of Steps	7.
Current per Step	10, 20, 50 μ A; 0.1, 0.2, 0.5, 1, 2mA; accuracy, $\pm 5\%$.
Volt per Step	0.1, 0.2, 0.5V; accuracy, $\pm 5\%$.
External Bias	One curve display.
Power Requirements	100, 120, 200, 220, or 240V, 50/60Hz, 25VA maximum operating, and 6VA at standby.
Size and Weight	240(W) \times 90(H) \times 170(D) mm, 2kg, (9 $\frac{1}{2}$ " \times 3 $\frac{1}{2}$ " \times 6 $\frac{3}{4}$ "; 4.5 lbs.)
Accessories	Instruction manual 1 3-lead cable (banana plugs/clips) 2 Scope leads, 2 red and 1 black 1 set In-circuit test probe, LP-11 1

3. CONTROLS AND CONNECTORS

- | | |
|-------------------|--|
| ① POWER switch | Turns on the AC power. |
| ② Pilot lamp | Indicates when AC power is on. |
| ③ POLARITY switch | Selects the mode of operation. |
| ④ VERTICAL jacks | Connections to vertical scope input. |
| ⑤ EXT. BIAS jack | Connection to an external source to apply base or gate bias for a one curve display. |

- ⑥ BASE CURRENT/
GATE VOLTAGE
switch
- ⑦ Banana plug jacks

Sets the bias current in eight steps and gate voltage in three steps; provided with position for external bias.

One group for test lead connections:

Color	Transistor	FET
Blue	C - Collector	D - Drain
Green	B - Base	G - Gate
Yellow	E - Emitter	S - Source

- ⑧ TO-5 socket
- ⑨ SELECTOR, lower
- ⑩ SELECTOR, upper
- ⑪ TO-5 socket
- ⑫ Banana plug jacks
- ⑬ COLLECTOR/DRAIN
SWEEP VOLTAGE
switch
- ⑭ CURRENT LIMIT
switch
- ⑮ H. LENGTH control
- ⑯ HORIZONTAL jacks

For insertion of transistor under test.

Selects input at "A" or "B" side. At OFF, both sides are disconnected.

Setting depends on type of transistor, NPN or PNP at TRANS; MOS FET and FET at FET.

Same as ⑧ .

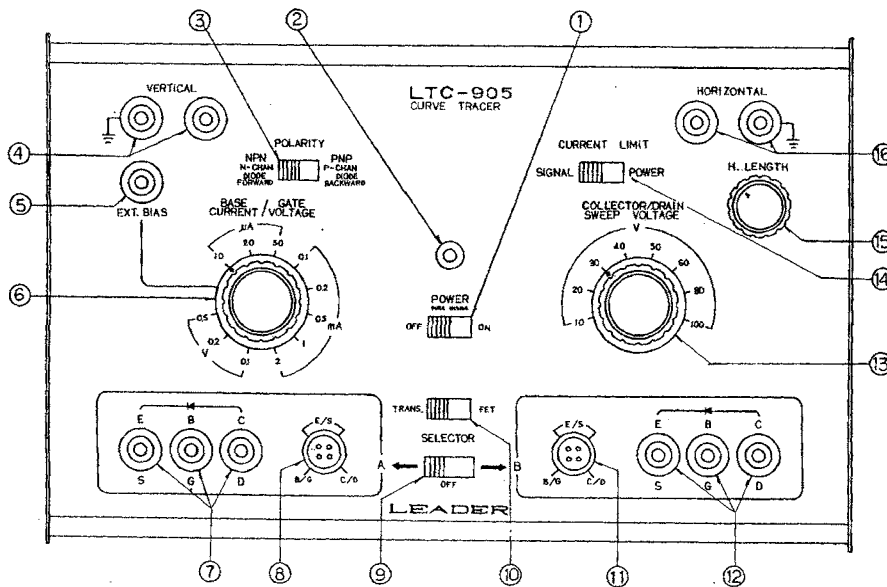
Same as ⑦ .

With eight positions for setting the sweep voltage.

Set at SIGNAL for low level types and at POWER for power types.

Adjusts the amplitude of the horizontal sweep on the scope.

Connections to horizontal scope input.



4. OPERATION

4.1 Preliminary Notes

A. AC Line Voltage.

The AC voltage for operation should be kept within $\pm 10\%$ of the rated value, see CHART 1. When low, the performance will be affected; when high, damage may result to circuit, components in the instrument.

CHART 1

Rating, V	Range, V	Fuse
100	90 - 110	0.5A
120	108 - 132	
200	180 - 220	
220	198 - 242	
240	216 - 264	

The line fuse is 0.5A for all voltages.

Refer to Sect. 7.3 for primary connections when different voltages are used.

B. AC Input Phasing.

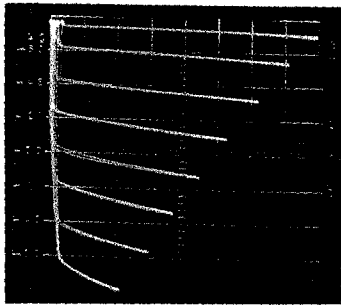


Fig. 4-1 Double curve effect,
AC phasing not proper.

Unless the phase of the AC voltage to the LTC-905 and scope are in proper relation, "double curves" will be displayed, see Fig. 4-1. This can be corrected by reversing the AC plug connection on the scope or LTC-905.

NOTE: When the scope is not provided with the DC input to the horizontal amplifier, the proper display may not be obtained.

C. Collector or Drain Sweep Application.

In order to protect the transistors and diodes against damage, care must be taken in application of the sweep voltage.

Voltages over 10V should not be used unless specially noted.

D. Scope Characteristics

The scope for curve tracing is used as an X-Y scope. It is necessary that the scope satisfies the conditions in CHART 2.

CHART 2

Amplifier	Bandwidth	Sensitivity, minimum
Vertical	DC - 1kHz or higher	0.1V/cm, or /div.
Horizontal	DC, or AC - 1kHz or higher	1V/cm, or /div.

In quantitative measurements, particularly for h_{FE} and g_m , a scope with the vertical gain calibrated in V/cm should be used. For ease in readouts, the V/cm sensitivities converted to the most used mA/cm calibration at two settings of the CURRENT LIMIT switch are listed in CHART 3.

CHART 3

Vertical Sensitivity	CURRENT LIMIT Setting	
	SIGNAL	POWER
50mV/cm	0.5mA/cm	5mA/cm
0.1V/cm	1mA/cm	10mA/cm
0.2V/cm	2mA/cm	20mA/cm
0.5V/cm	5mA/cm	50mA/cm

By adjusting the H. LENGTH control for the trace to cover 10cm, the V/cm unit horizontally can be correlated with the sweep voltage setting.

E. Scope Connections and Settings.

Connections between the scope and LTC-905 are made with the three leads as indicated in Fig. 4-2, red leads to vertical and horizontal inputs and black lead to common ground.

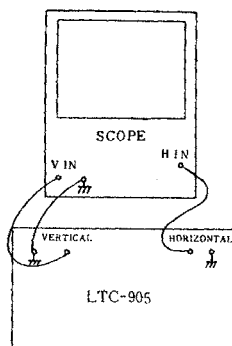


Fig. 4-2

Set the vertical gain initially at 100mV/cm and the AC-DC switch at DC.

Set the horizontal gain at maximum and the AC-DC switch at DC (use AC coupling if DC is not provided).

4.2 Preparation

Switch settings:

POWER	OFF.
CURRENT LIMIT	SIGNAL.
COLLECTOR/DRAIN SWEEP VOLTAGE	10V.
BASE / GATE CURRENT / VOLTAGE	EXT BIAS
SELECTOR: upper	Type under test, TRANSistor or FET.
lower	OFF.

Connections:

With proper attention to the terminals, the transistor is connected to the socket or leads from the three jacks at "A" or "B" side. When comparing two units, use the sockets and lead connections at both sides.

4.3 Transistor Measurements

4.3.1 NPN, low level.

Switch settings:

BASE CURRENT	10 μ A.
COLLECTOR SWEEP	10V.
POLARITY	NPN.
CURRENT LIMIT	SIGNAL.
SELECTOR: upper	TRANS.
lower	A or B, as connected.

The scope controls are adjusted for suitable display and proper positioning, see Fig. 4-3 and Fig. 4-4. Seven curves will be observed with Si transistors and eight curves with Ge transistors. This serves as a check.

When the BASE CURRENT is set at 20 μ A, the height will be doubled.

The transistor can be said to be satisfactory when the curves are displayed as shown in the figures.

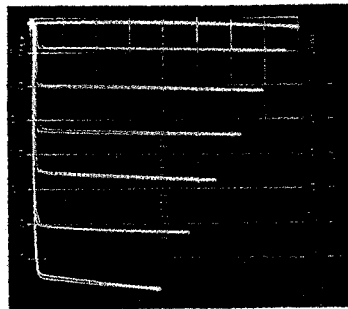


Fig. 4-3 Si transistor,
7 curves.

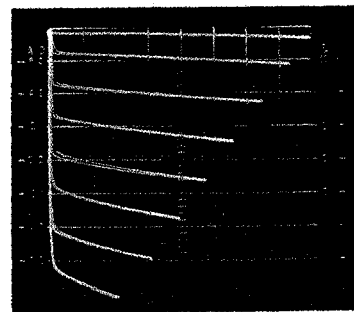


Fig. 4-4 Ge transistor,
8 curves.

4.3.2 NPN, power type.

For NPN power transistors, under the same conditions as in Sect. 4.3.1, set the CURRENT LIMIT at POWER and BASE CURRENT at 0.1 up to 1mA.

As the COLLECTOR SWEEP VOLTAGE is gradually raised from 10V upward.

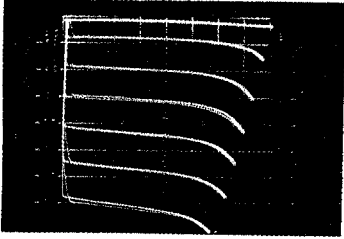


Fig. 4-5 Power transistor curves. The curves start to bend.

Do not increase the sweep voltage beyond the point where the curves start to bend, the curves will be as shown in Fig. 4-5. The region of the breakdown voltage can be read off.

For example, with the sweep voltage at 50V, adjust the H. LENGTH control for the sweep to cover 10cm horizontally, or 5V/cm, in this case. The collector-emitter voltage, V_{CE} , can be read easily.

By adjusting the H. LENGTH control for the trace to cover 10cm (or div.), the V/cm unit can be correlated with the voltage settings.

- NOTES:
1. When the sweep voltage and/or base current are increased, the transistor will become heated.
 2. Power transistors should be tested within as short a time as possible. This will prevent overheating when the sweep voltage is over 10V and/or when a large base current is flowing.

4.3.3 PNP, low level.

Switch settings:

BASE CURRENT	10 μ A.
COLLECTOR SWEEP	10V.
POLARITY	PNP.
CURRENT LIMIT	SIGNAL.
SELECTOR: upper	TRANS.
lower	A or B, as connected.



Fig. 4-6 PNP transistor curves.

The curve tracing procedure is the same as given in Sect. 4.3.1. The curve display will be as shown in Fig. 4-6.

4.3.4 PNP, power type.

Set the switches as in Sect. 4.3.2 above with the following exception:

POLARITY at PNP.

The curve tracing procedure is the same as described for NPN power transistors. The same care must be exercised to prevent overheating with high sweep voltages and base currents.

4.3.5 Measurement of h_{FE} .

Measurement of h_{FE} for an NPN transistor will be given; for the PNP type, the only changes will be in the setting of the POLARITY switch at PNP instead of NPN and in the direction of the curves.

The DC current amplification of a transistor is given by the relation -

$$h_{FE} = \frac{\text{Collector current, } I_C}{\text{Base current, } I_B}$$

For this measurement, a calibrated scope is required.

Referring to CHART 3 (Sect. 4.1, Parag. D) under SIGNAL of CURRENT LIMIT, the vertical gain is set at 0.1V/cm. Under this condition, the collector current is read off at 1mA/cm.

With the Si transistor, seven typical curves for I_B in $10\mu\text{A}$ steps from 0 to $60\mu\text{A}$ are shown in Fig. 4-7. On the $60\mu\text{A}$ curve, $I_C = 4.2\text{mA}$. By calculation,

$$h_{FE} = 4.2 \times 10^{-3} / 60 \times 10^{-6} = 70.$$

In Fig. 4-8, curves for a typical Ge transistor are shown. From the $I_B = 70\mu\text{A}$, $I_C = 2.1\text{mA}$ and $h_{FE} = 30$.

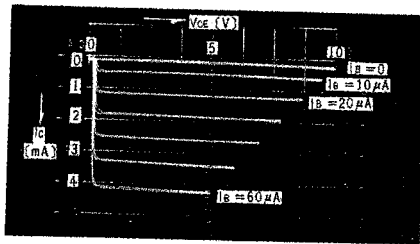


Fig. 4-7 h_{FE} measurement, Si transistor.

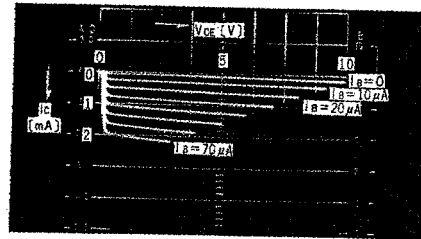


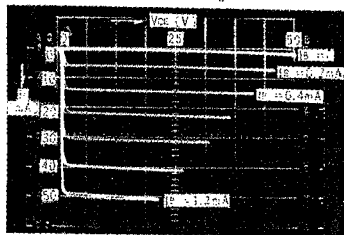
Fig. 4-8 h_{FE} measurement, Ge transistor.

In the two examples given above, h_{FE} measurements are collector-emitter voltage, $V_{CE} = 10\text{V}$. Other measurements can be made when required with the sweep voltage at 20, 30V, etc.

For h_{FE} of power transistors, set the CURRENT LIMIT switch at POWER and the POLARITY switch at NPN or PNP as required.

The scope sensitivity is set by reference to the POWER column of CURRENT LIMIT in CHART 3.

For example, with the sensitivity at 0.2V/cm, the calibration will be 20mA/cm. By setting the BASE CURRENT at 0.2mA, and SWEEP VOLTAGE at 50V (10cm length), curves in Fig. 4-9 will be displayed. From the figure, $I_B = 1.2\text{mA}$ and $I_C = 50\text{mA}$.



Thus, h_{FE} is approximately 41.7. Measurements of h_{FE} in this manner will be accurate within $\pm 10\%$.

For higher accuracy, use an external bias supply; details are given in Sect. 5.

Fig. 4-9 h_{FE} measurement, power transistor.

4.4 Measurement of FET's

4.4.1 N-channel FET, and N-channel MOS FET.

Switch settings:

GATE VOLTAGE	0.1V.
DRAIN SWEEP	10V.
POLARITY	N-CHAN.
CURRENT LIMIT	SIGNAL.
SELECTOR: upper	FET.
lower	A or B, as connected.

Eight curves will be displayed as shown in Fig. 4-10. As the sweep voltage is increased, the upper operating limits will be approached, see Fig. 4-11.

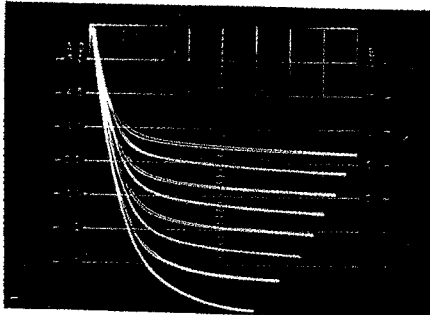


Fig. 4-10 Curves for N-channel FET and N-channel MOS FET.

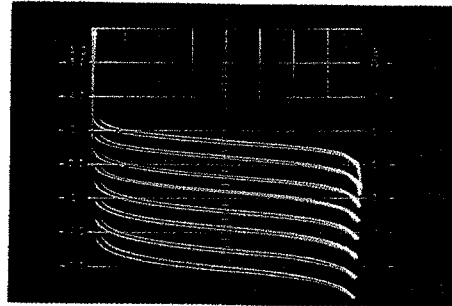


Fig. 4-11 Effect of increase in sweep voltage.

4.4.2 P-channel FET, and P-channel MOS FET.

Set the POLARITY switch at P-CHAN. Other switch settings are the same as in Sect. 4.4.1 above. Fig. 4-12 shows the curve display.

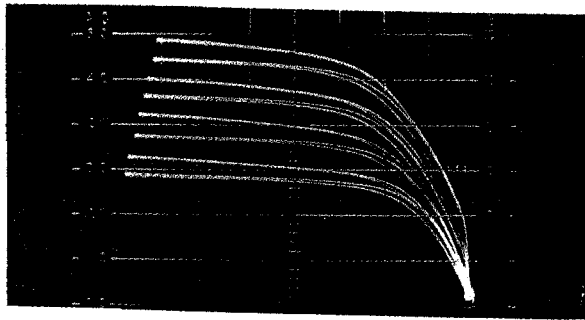


Fig. 4-12 Curves for P-channel FET and P-channel MOS FET.

4.4.3 Mutual conductance, g_m , measurement.

The g_m measurement for the N-channel FET will be described; for the P-channel FET, the only changes will be in the setting of the POLARITY switch at P-CHAN instead of N-CHAN, and the curve direction.

In the FET, mutual conductance defined by the relation -

$$g_m = \frac{\Delta I_D}{\Delta V_{GS}} \quad \text{at constant } V_{DS}$$

The switch settings are the same as given in Sect. 4.4.1.

The CURRENT LIMIT switch is set at SIGNAL; the scope is set at 0.1V/cm sensitivity. Under this condition, the drain current will be calibrated at 1mA/cm. The GATE VOLTAGE is set at 0.1V and trace length at 10cm.

In Fig. 4-13, eight curves are shown between $V_{GS} = 0$ to 0.7V. On the graticule, the drain current between these two voltages are read off. From the figure, the change in I_D is 2.1mA, and

$$g_m = \frac{2.1 \times 10^{-3}}{0.7} = 3 \times 10^{-3}, \text{ or 3 millimhos.}$$

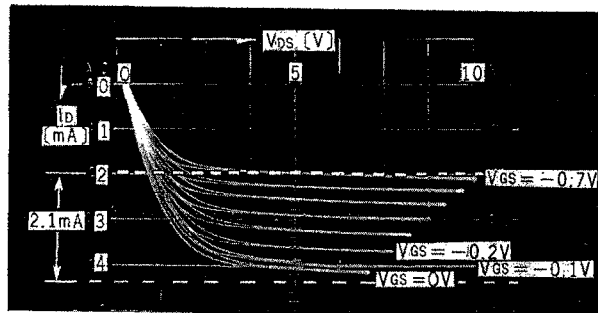


Fig. 4-13 g_m measurement in FET.

4.4.4 Enhancement type FET measurement.

There are two types of the MOS FET, depletion and enhancement. Measurements hitherto described relate to the N-channel FET of the depletion type wherein the drain current, I_D , decreases when the gate-source voltage, V_{GS} , is increased. In the enhancement type, there is practically no drain current when V_{GS} is zero but will increase when V_{GS} is applied in the positive direction.

Consequently, when testing the enhancement type, the upper SELECTOR switch must be set at TRANS. This will provide bias with the correct polarity. Other switch settings are the same as given in Sect. 4.4.1.

4.5 Diode Measurements

4.5.1 Standard test condition.

Switch settings:

COLLECTOR/DRAIN SWEEP	10V.
POLARITY	DIODE FORWARD.
CURRENT LIMIT	SIGNAL.
SELECTOR: upper	Any setting.
lower	A or B, as connected.

BASE CURRENT / GATE VOLTAGE

Any setting.

Connections:

The diode under test is connected to the tracer as follows: anode to collector jack and cathode to emitter jack, as shown on the panel marking at the A or B side.

4.5.2 General purpose: Power rectifiers and detectors.

Curves are shown in Fig. 4-14 for two characteristics, depending on the POLARITY switch settings, namely, DIODE FORWARD and DIODE BACKWARD. For the diode in good condition, the forward characteristic will be as shown.

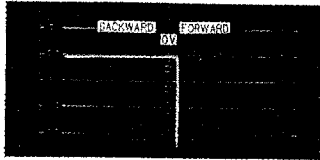


Fig. 4-14 Diode characteristics.

4.5.3 Zener diodes.

Under the standard test condition, set the POLARITY switch at DIODE BACKWARD. The curve displayed will be as shown in Fig. 4-15.

Depending on the characteristic, the sweep voltage can be increased to 20V or higher as required. By setting the POLARITY switch at DIODE FORWARD, the trace indicated with the dashed line will be displayed.

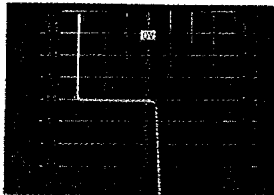


Fig. 4-15 Zener diode characteristics.

4.5.4 Tunnel diodes

Under the standard test condition, Sect. 4.5.1 above, the curve will be displayed as shown in Fig. 4-16.

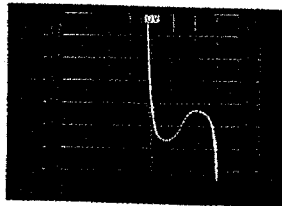


Fig. 4-16 Tunnel diode characteristics.

The curve at the right of the 0V axis with the polarity switch at DIODE FORWARD. There will be a blank in the curve (dashed part.) which is the negative resistance characteristic. The curve at the left of 0V axis will be displayed when the switch is set at DIODE BACKWARD.

4.5.5 Quantitative diode measurements

By calibrating the horizontal axis in V/cm, the current/voltage characteristic can be determined.

Set the trace length horizontally at 10cm. This will calibrate the sweep voltage at 1/10 (one-tenth) of the switch setting. For example, if set at 10V, then 1cm is equivalent to 1V.

With use of the calibrated vertical scale, the forward "rise" in diodes, zener breakdown voltage, etc., can be determined readily.

4.6 SCR (Thyristor) Measurements

Connections: See Fig. 4-17, and CHART 4 below.

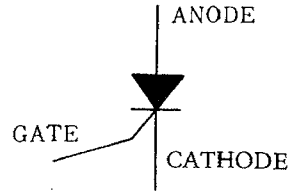


Fig. 4-17 SCR connections.

CHART 4

SCR	Transistor Equivalent
Cathode	Emitter, E
Gate	Base, B
Anode	Collector, C

Switch settings:

BASE CURRENT	10 μ A.
SWEEP VOLTAGE	10V, or as required.
POLARITY	NPN.
SELECTOR: upper	TRANS.
lower	A or B, as connected.

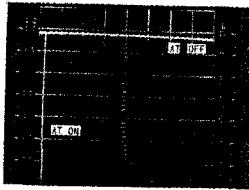


Fig. 4-18 shows the curves at on and off conditions.

Fig. 4-18 SCR characteristics.

4.7 UJT (Unijunction transistor) Measurements

Connections: See Fig. 4-19 and CHART 5 below.

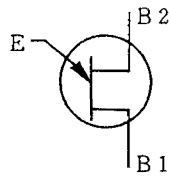


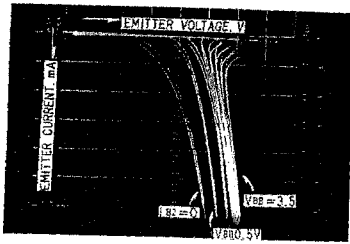
Fig. 4-19 UJT connections.

CHART 5

UJT	Transistor Equivalent
B ₁	Emitter, E
E	Collector, C
B ₂	Base, B

Switch settings:

GATE VOLTAGE	0.5V.
SWEEP VOLTAGE	10V.
POLARITY	NPN.
SELECTOR: upper	TRANS.
lower	A or B, as connected.



Curves for the UJT are shown Fig. 4-20. Since the curves will be close together, set the H. LENGTH control to full clockwise for spreading.

Fig. 4-20 UJT characteristics.

5. MEASUREMENTS WITH EXTERNAL BIAS

5.1 General

A single curve will be displayed when an external bias is applied to the transistor under test. Accurate measurements of h_{FE} and g_m are possible.

The bias current or voltage source is connected to the EXT BIAS jacks. The BASE CURRENT/GATE VOLTAGE switch is set at EXT BIAS.

5.2 Transistor Measurements

5.2.1 Bias supplies.

Circuits for supplying the external bias to the NPN and PNP transistors are shown in Fig. 5-1 and Fig. 5-2.

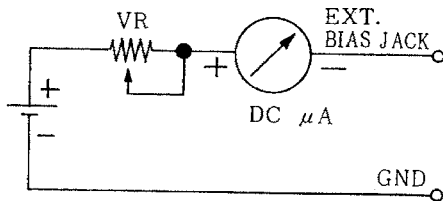


Fig. 5-1 NPN bias source

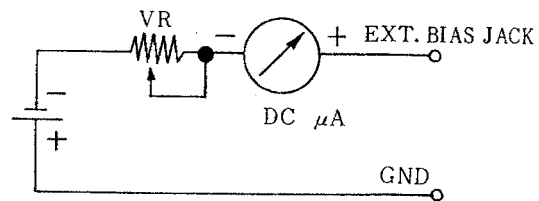


Fig. 5-2 PNP bias source.

The source, battery or regulated, should be in the 1 to 5V range; in most measurements, a 1.5V cell is sufficient.

The variable resistor VR, about $50k\Omega$, is used to adjust the current. A DC microammeter, 100 to $500\mu A$, will be suitable in most measurements. For power transistors, the range should be 1 to 5mA.

5.2.2 h_{FE} measurements.

Switch settings:

BASE CURRENT	EXT. BIAS.
SWEEP VOLTAGE	10V.
CURRENT LIMIT	SIGNAL.
SELECTOR: upper	TRANS.
lower	A or B, as connected.
POLARITY	NPN or PNP, depending on the transistor.

The scope sensitivity is set at 0.1V/cm for calibration at 1mA/cm.

Adjust the bias current with VR.

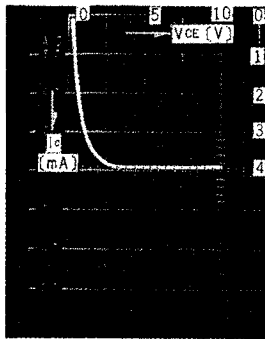


Fig. 5-3 h_{FE} measurement, NPN transistor.

The curve for an NPN transistor will be as shown in Fig. 5-3. For example, if the bias current, I_B , is set at $50\mu A$ and collector current, I_C , is $4mA$ (see curve), then

$$h_{FE} = \frac{\Delta I_C}{\Delta I_B} = \frac{4mA}{50\mu A} = \frac{4 \times 10^{-3}}{50 \times 10^{-6}} = 80.$$

The h_{FE} can be measured at different values of I_B with adjustment of VR.

For power transistors, set the CURRENT LIMIT switch at POWER and follow the same procedure.

For PNP transistors, set the POLARITY switch at PNP; the curve will be inverted.

5.2.3 I_{CEO} measurements.

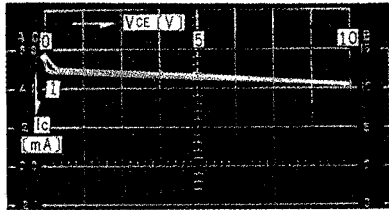


Fig. 5-4 I_{CEO} measurement, Ge transistor.

Disconnect the EXT BIAS connection, the I_{CEO} is measured.

(External bias is not used.)

Fig. 5-4 shows the curve for a Ge type transistor where the I_{CEO} is relatively high.

5.3 FET Measurements

5.3.1 Bias Supplies.

The bias voltage, V_{GS} , supplies for N-channel and P-channel FET's are shown in Fig. 5-5 and Fig. 5-6. The output is connected to the EXT BIAS jacks as indicated. The source, battery or regulated, should be in the 3 to 6V range. A $1k\Omega$ potentiometer, VR, and a suitable voltmeter are required.

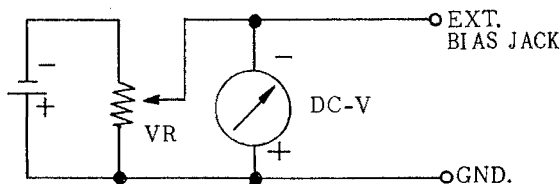


Fig. 5-5 N-channel FET bias source

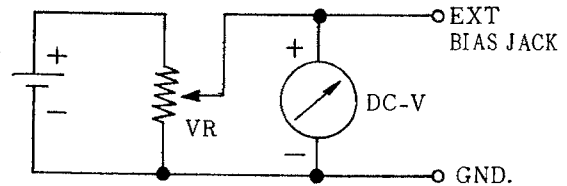


Fig. 5-6 P-channel FET bias source.

5.3.2 gm measurements.

Switch settings:

POLARITY	N-CHAN or P-CHAN, depending on FET.
GATE VOLTAGE	EXT BIAS.
SWEEP VOLTAGE	10V.
CURRENT LIMIT	SIGNAL.
SELECTOR: upper	FET
lower	A or B, as connected.

The scope sensitivity is set at 0.1V/cm for calibration at 1mA/cm to read I_D and for V_{DS} at 1V/cm with the H. LENGTH control.

Procedure:

1. Note the $I_{D(0)}$ reading at 0V bias on the $V_{GS} = 0V$ curve; the reading is taken where the curve flattens out, see Fig. 5-7.
2. Next, set the bias at $-0.5V$ and read $I_{D(-0.5V)}$ on the $V_{GS} = -0.5V$ curve.
3. The gm is defined as follows:

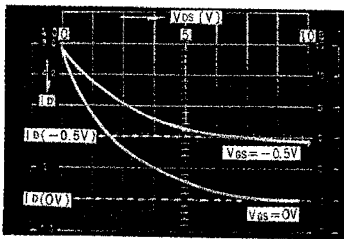
$$g_m = \frac{\Delta I_D}{\Delta V_{GS}}$$

where $\Delta I_D = I_{D(0)} - I_{D(-0.5V)}$, and

$$\Delta V_{GS} = 0V - (-0.5V) = 0.5V$$

Then

$$g_m = \frac{I_{D(0)} - I_{D(-0.5V)} \text{ mA}}{0.5V} \quad \text{in millimhos.}$$



In the above explanation, steps were given for gm measurement at $V_{GS} = 0V$ and $-0.5V$. Other measurements can be made with different values of V_{GS} .

For the P-channel transistors, the curves will be inverted.

Fig. 5-7 h_{FE} measurement
N-channel FET.

5.3.3 Pinch-off voltage, V_p , measurement.

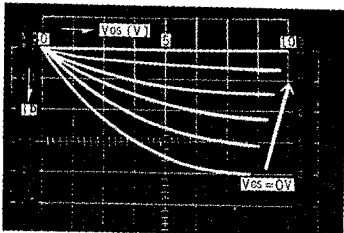


Fig. 5-8 pinch-off voltage measurement.

An example will be given for the N-channel FET.

The switches and scope controls are set as given in Sect. 5.3.2.

Using the bias source, Fig. 5-5, the voltage from 0V is increased in the minus direction. Curves will appear in the direction indicated by the arrow in Fig. 5-8.

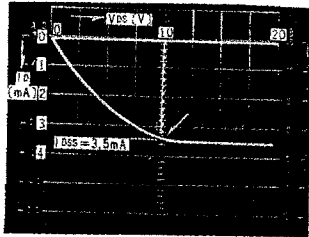
As more negative voltage is applied, the curve becomes straight. The bias voltage measured at this point is the Pinch-off voltage, V_p .

5.3.4 Drain current, I_{DSS} , measurements.

An N-channel FET will be used in the following example.

Disconnect the EXT BIAS connection and short the jack to ground. (External bias is not used.)

The switches and scope controls are set as given in Sect. 5.3.2.



The curve for I_{DSS} is shown in Fig. 5-9. I_{DSS} is read off at the point indicated with the arrow in the figure.

In general, the current is measured with V_{DS} at 10V and so the sweep voltage is set at 20V.

For FET's with high current, set the scope sensitivity at 0.2V/cm for the 2mA/cm calibration.

Fig. 5-9 I_{DSS} measurement.

6. IN-CIRCUIT TESTING

6.1 General

6.1.1 Application.

A valuable feature of the LTC-905 lies in its ability to test and/or compare transistors which are wired in TV receivers, radios and other electronic equipment.

Tests for quality are made by reference to the instructions given for transistors in the relevant sections on operation.

PRECAUTIONS:

1. For in-circuit testing, always turn off the operating power, AC or battery, to the equipment.
2. Confirm the type of transistor before testing by reference to the schematic or a handbook.
3. To prevent possible damage to the transistor and other circuit components, do not use more than 10V for the sweep voltage.

6.1.2 Use of In-Circuit Probe, LP-11

Instead of clips used in testing transistors and FET's which are mounted on circuit boards, the LP-11 Probe will be found very handy. The banana plugs are inserted in the panel jacks according to the color.

There are three sharp prods equipped with swivel joints on the probe head. It will be noted that two prods, blue for collector (drain) and yellow for emitter (source) are slightly longer than the green prod for base (gate).

In use, after checking the proper terminals on the circuit board, the two longer prods are connected first and the shorter prod is "bridged" for the connection. Sharp prods are used to pierce the insulation on the solder.

For safety, always put the cover over the prods after use.

6.2 Display of Defective Transistors, FET's

The conditions and typical displays of defective transistors and FET's will be given in this section.

1. Base-collector shorted in transistors.

Two displays are shown for the NPN type with base currents at $10\mu\text{A}$ and 0.2mA in Fig. 6-1 and Fig. 6-2. For the PNP type, the curves will be reversed in each figure.

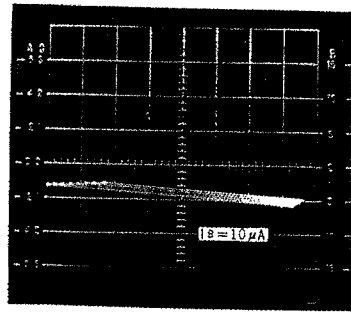


Fig. 6-1

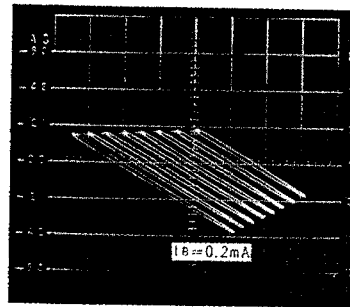


Fig. 6-2

2. Drain-gate shorted in FET's.

In Fig. 6-3 and Fig. 6-4, two conditions, with eight curves, are shown for the N-channel FET with gate voltages are 0.1V and 0.5V .

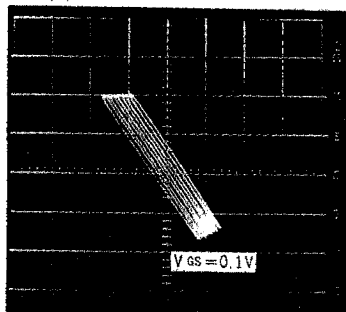


Fig. 6-3

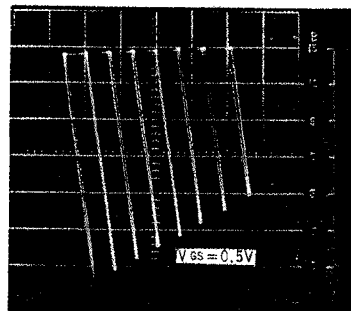


Fig. 6-4

3. Collector-emitter, or Drain-source, shorted, or total short.

Only a vertical line will be displayed, above (PNP) or below (NPN) the zero axis, see Fig. 6-5.

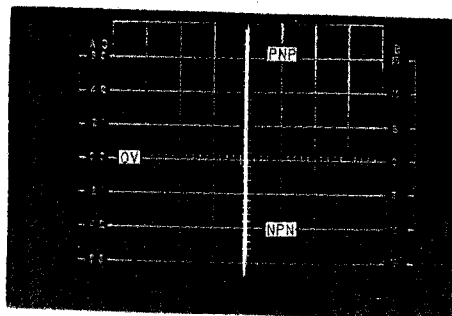


Fig. 6-5

4. Base-emitter, or Gate-source, Shorted or total open.

This condition is shown in Fig. 6-6 where there is no indication of the base current, or gate voltage.

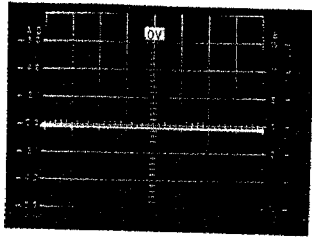


Fig. 6-6

6.3 Notes on In-Circuit Testing

The shape of the displayed curves will be affected by presence of associated circuit components. However, it may be assumed that the transistor or FET is satisfactory when a plurality of curves is displayed.

For example, typical curves for an NPN transistor in circuit are shown in Fig. 6-7. It will be seen that when the base current is increased, there will be considerable distortion in the curves.

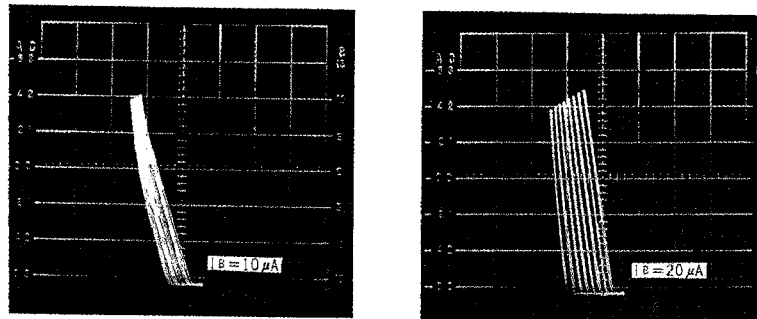


Fig. 6-7 In-circuit curves for NPN transistor.

In testing transistors, when only one curve is displayed, increase the base current from $10\mu\text{A}$ to $20\mu\text{A}$ or $50\mu\text{A}$. Typical curves for different base currents are shown in Fig. 6-8.

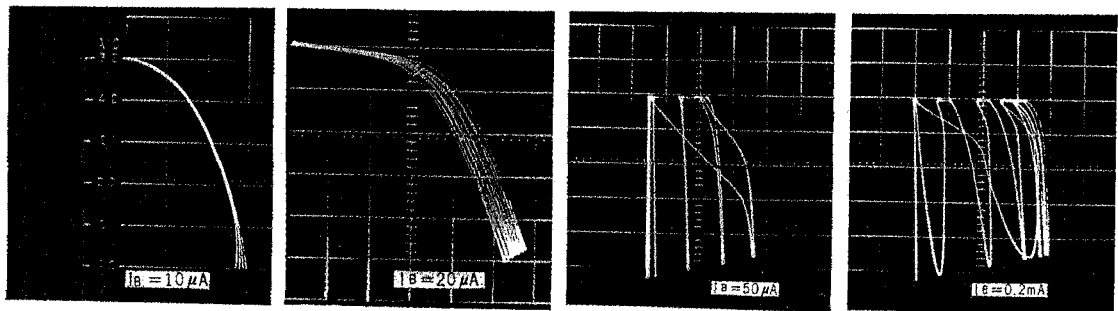


Fig. 6-8 Effect of increasing the base current.

For FET's, increase the gate voltage from 0.1V to 0.2V. When it is difficult to ascertain whether the unit defective, it should be tested after removal from the circuit board.

7. MAINTENANCE

7.1 Removing the Panel from Case

When it is necessary to inspect the internal circuitry of the LTC-905, the panel is removed from the case as follows:

1. Disconnect the AC plug from the AC line.
2. Remove the screw at the underside of the case.
3. Remove four screws on the panel and pull out the panel from the case.

7.2 Fuse Renewal

The fuse, 0.5A, is located on a PCB in the case, see Fig. 7-1.

If the fuse blows after replacement, check the DC power supply circuit for defective components.

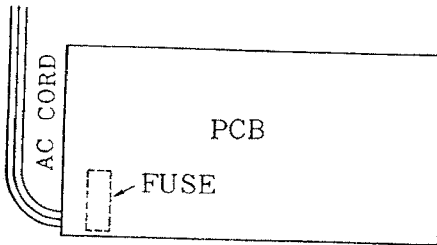


Fig. 7-1 Location of fuse.

7.3 AC Input Connections

The input connections for different AC voltages are shown in Fig. 7-2. The taps are on the power transformer terminal board.

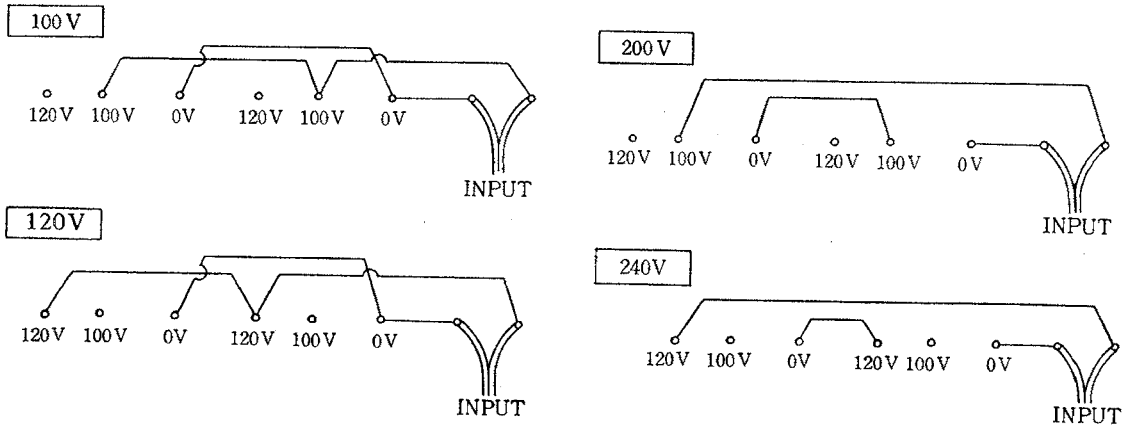
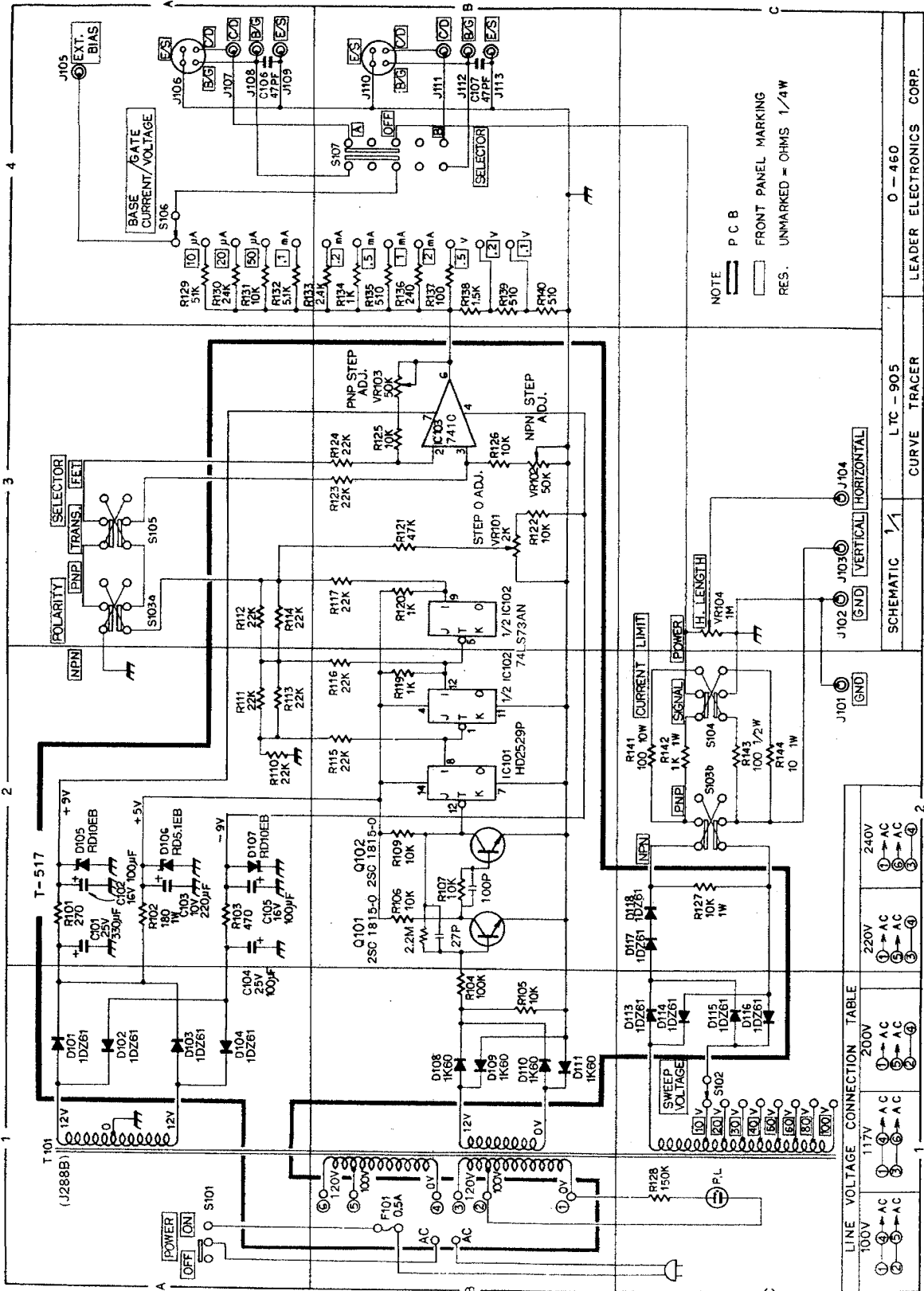


Fig. 7-2 AC input connections on power transformer.



NOTE
 P C B
 FRONT PANEL MARKING
 RES. UNMARKED = OHMS 1/4W

SCHEMATIC 1/1
 CURVE TRACER
 L T C - 905
 LEADER ELECTRONICS CORP.
 O - 460